

# LMH6551Q Differential, High Speed Op Amp

Check for Samples: LMH6551Q

### **FEATURES**

- 370 MHz -3 dB Bandwidth ( $V_{OUT} = 0.5 V_{PP}$ )
- 50 MHz 0.1 dB Bandwidth
- 2400 V/µs Slew Rate
- 18 ns Settling Time to 0.05%
- -94/-96 dB HD2/HD3 @ 5 MHz
- LMH6551Q is AEC-Q100 Grade 1 Qualified and is Manufactured on an Automotive Grade Flow

## **APPLICATIONS**

- **Differential AD Driver**
- Video Over Twisted Pair
- **Differential Line Driver**
- Single End to Differential Converter
- **High Speed Differential Signaling**
- IF/RF Amplifier
- SAW Filter Buffer/Driver
- **Automotive**

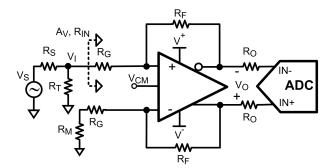
# Typical Application

### DESCRIPTION

The LMH™6551Q is a high performance voltage feedback differential amplifier. The LMH6551Q has the high speed and low distortion necessary for driving high performance ADCs as well as the current handling capability to drive signals over balanced transmission lines like CAT 5 data cables. The LMH6551Q can handle a wide range of video and data formats.

With external gain set resistors, the LMH6551Q can be used at any desired gain. Gain flexibility coupled with high speed makes the LMH6551Q suitable for use as an IF amplifier in high performance communications equipment.

The LMH6551Q is available in the VSSOP package.



# For $R_M \ll R_G$ :

$$\begin{aligned} A_{_{V}} &= \frac{V_{_{O}}}{V_{_{I}}} \cong \frac{R_{_{F}}}{R_{_{G}}} \\ R_{_{IN}} &\cong \frac{2R_{_{G}}(1+A_{_{V}})}{2+A_{_{V}}} \end{aligned} \qquad 1) \operatorname{Set} R_{_{T}} = \frac{1}{\frac{1}{R_{_{S}}} - \frac{1}{R_{_{IN}}}} \\ 2) \operatorname{Set} R_{_{M}} &= R_{_{T}} \parallel R_{_{S}} \end{aligned}$$

1) Set 
$$R_{T} = \frac{1}{\frac{1}{R_{S}} - \frac{1}{R_{IN}}}$$

2) Set 
$$R_{M} = R_{T} \mid\mid R_{S}$$

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## **Connection Diagram**

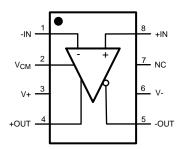


Figure 1. Top View 8-Pin VSSOP See Package Number DGK



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## Absolute Maximum Ratings (1)(2)

, about and maximum readings		
ESD Tolerance (3)	Human Body Model	2000V
	Machine Model	200V
Supply Voltage	13.2V	
Common Mode Input Voltage		±Vs
Maximum Input Current (pins 1, 2, 7, 8)		30mA
Maximum Output Current (pins 4, 5)		(4)
Maximum Junction Temperature		150°C
Soldering Information: http://www.ti.com/li	t/SNOA549	

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications, see the Electrical Characteristics tables.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/ Distributors for availability and specifications.
- (3) Human body model: 1.5 kΩ in series with 100 pF. Machine model: 0Ω in series with 200pF.
- (4) The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations.

# Operating Ratings (1)

Operating Temperature Range	−40°C to +125°C
Storage Temperature Range	−65°C to +150°C
Total Supply Voltage	3V to 11V
Package Thermal Resistance (θ <sub>JA</sub> ) <sup>(2)</sup>	
8-Pin VSSOP	159°C/W

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but specific performance is not ensured. For ensured specifications, see the Electrical Characteristics tables.
- (2) The maximum power dissipation is a function of  $T_{J(MAX)}$ ,  $\theta_{JA}$  and  $T_A$ . The maximum allowable power dissipation at any ambient temperature is  $P_{D} = (T_{J(MAX)} T_A)/\theta_{JA}$ . All numbers apply for package soldered directly into a 4 layer PC board with zero air flow.



## ±5V Electrical Characteristics (1)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = ±5V,  $V_{CM}$  = 0V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
AC Perfori	nance (Differential)					
SSBW	Small Signal -3 dB Bandwidth	$V_{OUT} = 0.5 V_{PP}$		370		MHz
LSBW	Large Signal -3 dB Bandwidth	V <sub>OUT</sub> = 2 V <sub>PP</sub>		340		MHz
	Large Signal -3 dB Bandwidth	V <sub>OUT</sub> = 4 V <sub>PP</sub>		320		MHz
	0.1 dB Bandwidth	V <sub>OUT</sub> = 2 V <sub>PP</sub>		50		MHz
	Slew Rate	4V Step <sup>(4)</sup>		2400		V/µs
	Rise/Fall Time	2V Step		1.8		ns
	Settling Time	2V Step, 0.05%		18		ns
V <sub>CM</sub> Pin A	C Performance (Common Mode Feedb	ack Amplifier)				
	Common Mode Small Signal Bandwidth	V <sub>CM</sub> bypass capacitor removed		200		MHz
Distortion	and Noise Response					
HD2		$V_{O} = 2 V_{PP}, f = 5 MHz, R_{L} = 800\Omega$		-94		dBc
HD2		$V_{O} = 2 V_{PP}, f = 20MHz, R_{L} = 800\Omega$		-85		dBc
HD3		$V_{O} = 2 V_{PP}, f = 5 MHz, R_{L} = 800\Omega$		-96		dBc
HD3		$V_{O} = 2 V_{PP}, f = 20 MHz, R_{L} = 800\Omega$		-72		dBc
e <sub>n</sub>	Input Referred Voltage Noise	Freq ≥ 1 MHz		6.0		nV/√ <del>Hz</del>
i <sub>n</sub>	Input Referred Noise Current	Freq ≥ 1 MHz		1.5		pA/√Hz
Input Char	acteristics (Differential)					
V <sub>OSD</sub>	Input Offset Voltage	Differential Mode, V <sub>ID</sub> = 0, V <sub>CM</sub> = 0		0.5	±4 <b>±6</b>	mV
	Input Offset Voltage Average Temperature Drift	(5)		-0.8		μV/°C
I <sub>BI</sub>	Input Bias Current	(6)		-4	0 -10	μΑ
	Input Bias Current Average Temperature Drift	(5)		-2.6		nA/°C
	Input Bias Difference	Difference in Bias currents between the two inputs		0.03		μΑ
CMRR	Common Mode Rejection Ratio	DC, $V_{CM} = 0V$ , $V_{ID} = 0V$	70	80		dBc
R <sub>IN</sub>	Input Resistance	Differential		5		МΩ
C <sub>IN</sub>	Input Capacitance	Differential		1		pF
CMVR	Input Common Mode Voltage Range	CMRR > 53dB	+3.1 -4.6	+3.2 -4.7		V

Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ . Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods.

Product Folder Links: LMH6551Q

Typical numbers are the most likely parametric norm.

Slew Rate is the average of the rising and falling edges.

Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.

Negative input current implies current flowing out of the device.



# ±5V Electrical Characteristics (1) (continued)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = ±5V,  $V_{CM}$  = 0V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
V <sub>CM</sub> Pin Inp	out Characteristics (Common Mode Fee	edback Amplifier)				
V <sub>OSC</sub>	Input Offset Voltage	Common Mode, V <sub>ID</sub> = 0		0.5	±5 <b>±8</b>	mV
	Input Offset Voltage Average Temperature Drift	(7)		8.2		μV/°C
	Input Bias Current	(8)		-2		μΑ
	V <sub>CM</sub> CMRR	$V_{ID}$ = 0V, 1V step on $V_{CM}$ pin, measure $V_{OD}$	70	75		dB
	Input Resistance			25		kΩ
	Common Mode Gain	$\Delta V_{O,CM}/\Delta V_{CM}$	0.995	0.999	1.005	V/V
Output Per	rformance					
	Output Voltage Swing	Single Ended, Peak to Peak	±7.38 <b>±7.18</b>	±7.8		V
	Output Common Mode Voltage Range	V <sub>ID</sub> = 0 V,	±3.69	±3.8		V
I <sub>OUT</sub>	Linear Output Current	V <sub>OUT</sub> = 0V	±50	±65		mA
I <sub>SC</sub>	Short Circuit Current	Output Shorted to Ground V <sub>IN</sub> = 3V Single Ended <sup>(9)</sup> I		140		mA
	Output Balance Error	$\Delta V_{OUT}$ Common Mode $/\Delta V_{OUT}$ Differential, $V_{OUT} = 0.5 \text{ Vpp}$ Differential, f = 10 MHz		-70		dB
Miscellane	ous Performance					
A <sub>VOL</sub>	Open Loop Gain	Differential		70		dB
PSRR	Power Supply Rejection Ratio	DC, $\Delta V_S = \pm 1V$	71	90		dB
	Supply Current	R <sub>L</sub> = ∞	11	12.5	14.5 <b>16.5</b>	mA

- (7) Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.
- (8) Negative input current implies current flowing out of the device.
- 9) The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations.

# 5V Electrical Characteristics (1)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = 5V,  $V_{CM}$  = 2.5V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
SSBW	Small Signal -3 dB Bandwidth	$R_L = 500\Omega$ , $V_{OUT} = 0.5 V_{PP}$		350		MHz
LSBW	Large Signal -3 dB Bandwidth	$R_L = 500\Omega$ , $V_{OUT} = 2 V_{PP}$		300		MHz
	0.1 dB Bandwidth	$V_{OUT} = 2 V_{PP}$		50		MHz
	Slew Rate	4V Step <sup>(4)</sup>		1800		V/µs
	Rise/Fall Time, 10% to 90%	4V Step		2		ns
	Settling Time	4V Step, 0.05%		17		ns
V <sub>CM</sub> Pin AC	Performance (Common Mode Fee	dback Amplifier)	·			
	Common Mode Small Signal Bandwidth			170		MHz

- (1) Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that T<sub>J</sub> = T<sub>A</sub>. No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where T<sub>J</sub> > T<sub>A</sub>.
- (2) Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlation using Statistical Quality Control (SQC) methods.
- (3) Typical numbers are the most likely parametric norm.
- (4) Slew Rate is the average of the rising and falling edges.

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# 5V Electrical Characteristics (1) (continued)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = 5V,  $V_{CM}$  = 2.5V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
Distortion	and Noise Response					
HD2	2 <sup>nd</sup> Harmonic Distortion	$V_{O} = 2 V_{PP}, f = 5 MHz, R_{L}=800\Omega$		-84		dBc
HD2		$V_{O} = 2 V_{PP}, f = 20 \text{ MHz}, R_{L} = 800\Omega$		-69		dBc
HD3	3 <sup>rd</sup> Harmonic Distortion	$V_{O} = 2 V_{PP}, f = 5 MHz, R_{L} = 800\Omega$		-93		dBc
HD3		$V_{O} = 2 V_{PP}, f = 20 MHz, R_{L} = 800\Omega$		-67		dBc
e <sub>n</sub>	Input Referred Noise Voltage	Freq ≥ 1 MHz		6.0		nV/√ <del>Hz</del>
i <sub>n</sub>	Input Referred Noise Current	Freq ≥ 1 MHz		1.5		pA/√ <del>Hz</del>
Input Cha	racteristics (Differential)	'		II.	11	
V <sub>OSD</sub>	Input Offset Voltage	Differential Mode, V <sub>ID</sub> = 0, V <sub>CM</sub> = 0		0.5	±4 <b>±6</b>	mV
	Input Offset Voltage Average Temperature Drift	(5)		-0.8		μV/°C
I <sub>BIAS</sub>	Input Bias Current	(6)		-4	0 <b>-10</b>	μΑ
	Input Bias Current Average Temperature Drift	(5)		-3		nA/°C
	Input Bias Current Difference	Difference in Bias currents between the two inputs		0.03		μΑ
CMRR	Common-Mode Rejection Ratio	DC, $V_{ID} = 0V$	70	78		dBc
	Input Resistance	Differential		5		ΜΩ
	Input Capacitance	Differential		1		pF
V <sub>ICM</sub>	Input Common Mode Range	CMRR > 53 dB	+3.1 +0.4	+3.2 +0.3		
V <sub>CM</sub> Pin In	put Characteristics (Common Mode	Feedback Amplifier)				
	Input Offset Voltage	Common Mode, V <sub>ID</sub> = 0		0.5	±5 <b>±8</b>	mV
	Input Offset Voltage Average Temperature Drift			5.8		μV/°C
	Input Bias Current			3		μΑ
	V <sub>CM</sub> CMRR	$V_{ID} = 0$ , 1V step on $V_{CM}$ pin, measure $V_{OD}$	70	75		dB
	Input Resistance	V <sub>CM</sub> pin to ground		25		kΩ
	Common Mode Gain	$\Delta V_{O,CM}/\Delta V_{CM}$	0.995	0.999	1.005	V/V
Output Pe	erformance	•				
V <sub>OUT</sub>	Output Voltage Swing	Single Ended, Peak to Peak, $V_S = \pm 2.5V$ , $V_{CM} = 0V$	±2.4	±2.8		V
I <sub>OUT</sub>	Linear Output Current	V <sub>OUT</sub> = 0V Differential	±45	±60		mA
I <sub>SC</sub>	Output Short Circuit Current	Output Shorted to Ground V <sub>IN</sub> = 3V Single Ended <sup>(7)</sup>		230		mA
CMVR	Output Common Mode Voltage Range	$V_{ID} = 0$ , $V_{CM}pin = 1.2V$ and 3.8V	1.23 3.72	1.20 3.80		V
	Output Balance Error	$ \begin{array}{l} \Delta V_{OUT} Common \ Mode \ / \Delta V_{OUT} D If ferential, \\ V_{OUT} = 1 Vpp \ Differential, \ f = 10 \ MHz \end{array} $		-65		dB
Miscellan	eous Performance					
	Open Loop Gain	DC, Differential		70		dB
PSRR	Power Supply Rejection Ratio	DC, $\Delta V_S = \pm 0.5V$	71	88		dB
Is	Supply Current	R <sub>L</sub> = ∞	10	11.5	13.5 <b>15.5</b>	mA

 <sup>(5)</sup> Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.
 (6) Negative input current implies current flowing out of the device.

Product Folder Links: LMH6551Q

The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations.



# 3.3V Electrical Characteristics (1)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = 3.3V,  $V_{CM}$  = 1.65V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
SSBW	Small Signal -3 dB Bandwidth	$R_L = 500\Omega$ , $V_{OUT} = 0.5 V_{PP}$		320		MHz
LSBW	Large Signal -3 dB Bandwidth	$R_L = 500\Omega$ , $V_{OUT} = 1 V_{PP}$		300		MHz
	Slew Rate	1V Step <sup>(4)</sup>		700		V/µs
	Rise/Fall Time, 10% to 90%	1V Step		2		ns
V <sub>CM</sub> Pin A	Performance (Common Mode Fe	edback Amplifier)	*		-	-
	Common Mode Small Signal Bandwidth			95		MHz
Distortion	and Noise Response		<u> </u>			
HD2	2 <sup>nd</sup> Harmonic Distortion	$V_{O} = 1 V_{PP}, f = 5 MHz, R_{L} = 800\Omega$		-93		dBc
HD2		$V_{O} = 1 V_{PP}, f = 20 MHz, R_{L} = 800\Omega$		-74		dBc
HD3	3 <sup>rd</sup> Harmonic Distortion	$V_{O} = 1V_{PP}, f = 5 \text{ MHz}, R_{L} = 800\Omega$		-85		dBc
HD3		$V_{O} = 1V_{PP}, f = 20 \text{ MHz}, R_{L} = 800\Omega$		-69		dBc

<sup>(1)</sup> Electrical Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No specification of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ . Limits are 100% production tested at 25°C. Limits over the operating temperature range are ensured through correlation using Statistical

Quality Control (SQC) methods.

Typical numbers are the most likely parametric norm.

Slew Rate is the average of the rising and falling edges.



# 3.3V Electrical Characteristics (1) (continued)

Single ended in differential out,  $T_A$ = 25°C, G = +1,  $V_S$  = 3.3V,  $V_{CM}$  = 1.65V,  $R_F$  =  $R_G$  = 365 $\Omega$ ,  $R_L$  = 500 $\Omega$ ; Unless specified **Boldface** limits apply at the temperature extremes.

Symbol	Parameter	Conditions	Min <sup>(2)</sup>	Typ <sup>(3)</sup>	Max <sup>(2)</sup>	Units
Input Char	acteristics (Differential)					
V <sub>OSD</sub>	Input Offset Voltage	Differential Mode, V <sub>ID</sub> = 0, V <sub>CM</sub> = 0		1		mV
	Input Offset Voltage Average Temperature Drift	(5)		1.6		μV/°C
I <sub>BIAS</sub>	Input Bias Current	(6)		-8		μA
	Input Bias Current Average Temperature Drift	(5)		9.5		nA/°C
	Input Bias Current Difference	Difference in Bias currents between the two inputs		0.3		μΑ
CMRR	Common-Mode Rejection Ratio	DC, V <sub>ID</sub> = 0V		78		dBc
	Input Resistance	Differential		5		ΜΩ
	Input Capacitance	Differential		1		pF
V <sub>ICM</sub>	Input Common Mode Range	CMRR > 53 dB		+1.5 +0.3		
V <sub>CM</sub> Pin Inp	out Characteristics (Common Mode	Feedback Amplifier)				
	Input Offset Voltage	Common Mode, V <sub>ID</sub> = 0		1	±5	mV
	Input Offset Voltage Average Temperature Drift			18.6		μV/°C
	Input Bias Current			3		μA
	V <sub>CM</sub> CMRR	$V_{ID} = 0$ , 1V step on $V_{CM}$ pin, measure $V_{OD}$		60		dB
	Input Resistance	V <sub>CM</sub> pin to ground		25		kΩ
	Common Mode Gain	$\Delta V_{O,CM}/\Delta V_{CM}$		0.999		V/V
Output Per	rformance					
V <sub>OUT</sub>	Output Voltage Swing	Single Ended, Peak to Peak, V <sub>S</sub> = 3.3V, V <sub>CM</sub> = 1.65V	±0.75	±0.9		V
I <sub>OUT</sub>	Linear Output Current	V <sub>OUT</sub> = 0V Differential	±30	±40		mA
I <sub>SC</sub>	Output Short Circuit Current	Output Shorted to Ground V <sub>IN</sub> = 2V Single Ended <sup>(7)</sup>		200		mA
CMVR	Output Common Mode Voltage Range	$V_{ID} = 0$ , $V_{CM}pin = 1.2V$ and 2.1V		2.1 1.2		V
	Output Balance Error	$ \begin{array}{l} \Delta V_{OUT} Common \ Mode \ / \Delta V_{OUT} D \ If ferential, \\ V_{OUT} = 1 Vpp \ Differential, \ f = 10 \ MHz \end{array} $		-65		dB
Miscellane	ous Performance					
	Open Loop Gain	DC, Differential		70		dB
PSRR	Power Supply Rejection Ratio	DC, $\Delta V_S = \pm 0.5V$		75		dB
I <sub>S</sub>	Supply Current	R <sub>L</sub> = ∞		8		mA

Drift determined by dividing the change in parameter at temperature extremes by the total temperature change.

Product Folder Links: LMH6551Q

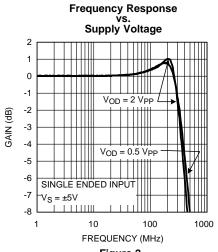
Negative input current implies current flowing out of the device.

The maximum output current (I<sub>OUT</sub>) is determined by device power dissipation limitations.

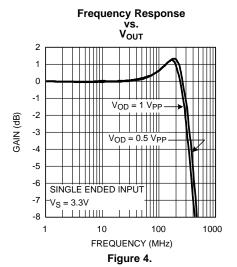


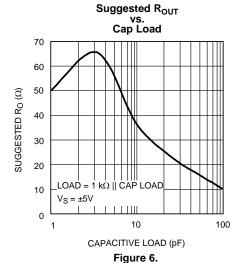
## **Typical Performance Characteristics**

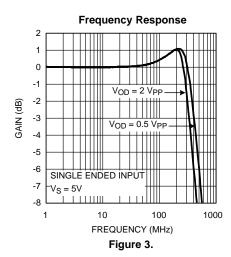
 $(T_A = 25^{\circ}C, V_S = \pm 5V, R_L = 500\Omega, R_F = R_G = 365\Omega; Unless Specified).$ 



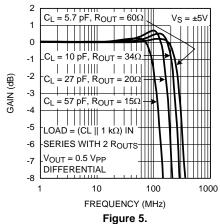








Frequency Response vs.
Capacitive Load



Suggested R<sub>OUT</sub> vs. Cap Load 70 60 50 SUGGESTED R<sub>O</sub> (Ω) 40 30 20 \_LOAD = 1 kΩ || CAP LOAD 10  $V_S = 5V$ 0 10 100 CAPACITIVE LOAD (pF)

Figure 7.



# **Typical Performance Characteristics (continued)**

(T<sub>A</sub> = 25°C, V<sub>S</sub> =  $\pm$ 5V, R<sub>L</sub> = 500 $\Omega$ , R<sub>F</sub> = R<sub>G</sub> = 365 $\Omega$ ; Unless Specified).

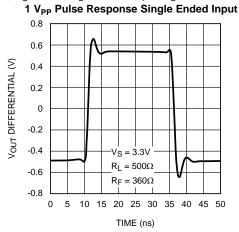
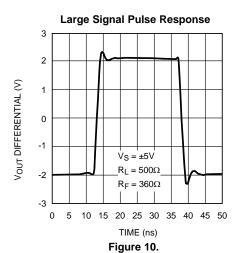
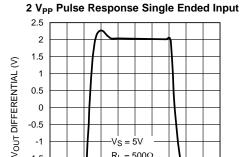


Figure 8.



Distortion vs. Frequency -50  $V_S = \pm 5V$ V<sub>OUT</sub> = 2 V<sub>PP</sub> -60  $V_{CM} = 0V$  $R_L = 800\Omega$ DISTORTION (dBc) -70 -80 -90 HD2 -100 -110 0 5 15 20 25 FREQUENCY (MHz)

Figure 12.



TIME (ns) Figure 9.

 $_{\mathsf{L}}\mathsf{R}_{\mathsf{L}}=500\Omega$ 

 $R_F = 360\Omega$ 

10 15 20 25 30 35 40 45 50

-1.5

-2

-2.5

0

5



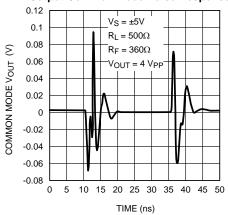


Figure 11.

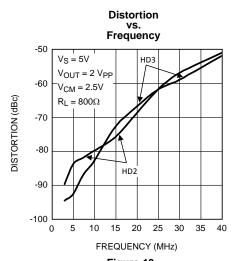


Figure 13.



## **Typical Performance Characteristics (continued)**

(T<sub>A</sub> = 25°C, V<sub>S</sub> =  $\pm$ 5V, R<sub>L</sub> = 500 $\Omega$ , R<sub>F</sub> = R<sub>G</sub> = 365 $\Omega$ ; Unless Specified).

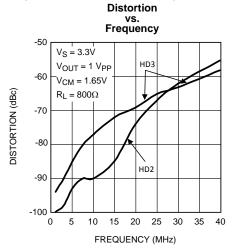
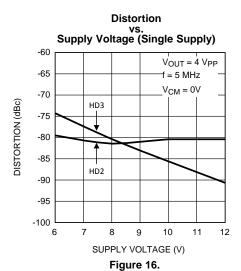


Figure 14.



 $\underset{[vs.}{\text{Minimum}} \ v_{\text{out}}$ 

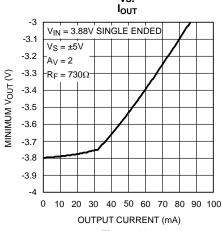


Figure 18.

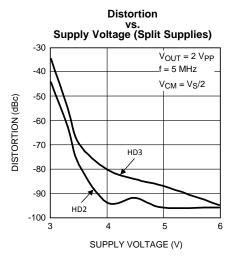
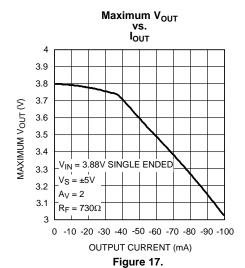


Figure 15.



**Closed Loop Output Impedance** 

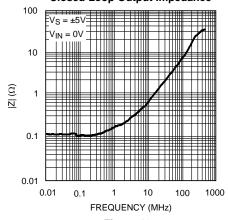


Figure 19.



# **Typical Performance Characteristics (continued)**

(T<sub>A</sub> = 25°C, V<sub>S</sub> =  $\pm$ 5V, R<sub>L</sub> = 500 $\Omega$ , R<sub>F</sub> = R<sub>G</sub> = 365 $\Omega$ ; Unless Specified).

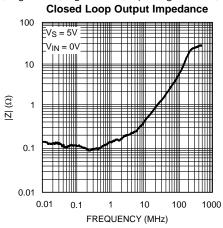


Figure 20.

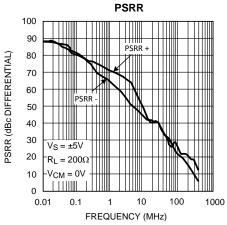
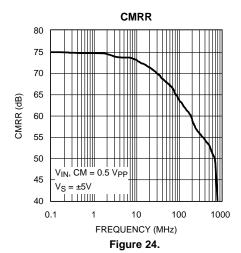


Figure 22.





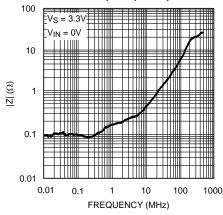


Figure 21.

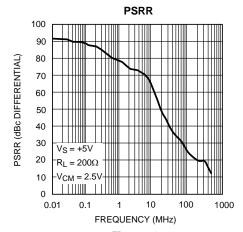
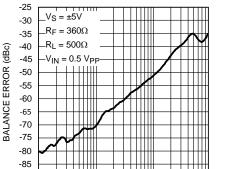


Figure 23.

Balance Error



FREQUENCY (MHz)
Figure 25.

10

-90

1000



#### APPLICATION SECTION

The LMH6551Q is a fully differential amplifier designed to provide low distortion amplification to wide bandwidth differential signals. The LMH6551Q, though fully integrated for ultimate balance and distortion performance, functionally provides three channels. Two of these channels are the  $V^+$  and  $V^-$  signal path channels, which function similarly to inverting mode operational amplifiers and are the primary signal paths. The third channel is the common mode feedback circuit. This is the circuit that sets the output common mode as well as driving the  $V^+$  and  $V^-$  outputs to be equal magnitude and opposite phase, even when only one of the two input channels is driven. The common mode feedback circuit allows single ended to differential operation.

The LMH6551Q is a voltage feedback amplifier with gain set by external resistors. Output common mode voltage is set by the  $V_{CM}$  pin. This pin should be driven by a low impedance reference and should be bypassed to ground with a 0.1  $\mu$ F ceramic capacitor. Any signal coupling into the  $V_{CM}$  will be passed along to the output and will reduce the dynamic range of the amplifier.

#### **FULLY DIFFERENTIAL OPERATION**

The LMH6551Q will perform best when used with split supplies and in a fully differential configuration. See Figure 26 and Figure 27 for recommended circuits.

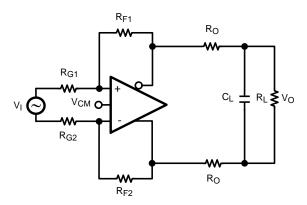


Figure 26. Typical Application

The circuit shown in Figure 26 is a typical fully differential application as might be used to drive an ADC. In this circuit closed loop gain,  $(A_V) = V_{OUT}/V_{IN} = R_F/R_G$ . For all the applications in this data sheet  $V_{IN}$  is presumed to be the voltage presented to the circuit by the signal source. For differential signals this will be the difference of the signals on each input (which will be double the magnitude of each individual signal), while in single ended inputs it will just be the driven input signal.

The resistors  $R_O$  help keep the amplifier stable when presented with a load  $C_L$  as is typical in an analog to digital converter (ADC). When fed with a differential signal, the LMH6551 provides excellent distortion, balance and common mode rejection provided the resistors  $R_F$ ,  $R_G$  and  $R_O$  are well matched and strict symmetry is observed in board layout. With a DC CMRR of over 80dB, the DC and low frequency CMRR of most circuits will be dominated by the external resistors and board trace resistance. At higher frequencies board layout symmetry becomes a factor as well. Precision resistors of at least 0.1% accuracy are recommended and careful board layout will also be required.



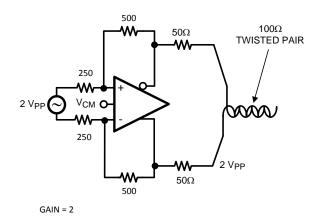
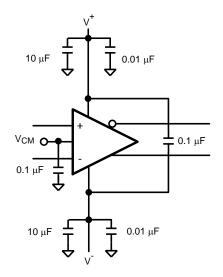


Figure 27. Fully Differential Cable Driver

With up to 15  $V_{PP}$  differential output voltage swing and 80 mA of linear drive current the LMH6551Q makes an excellent cable driver as shown in Figure 27. The LMH6551Q is also suitable for driving differential cables from a single ended source.

The LMH6551Q requires supply bypassing capacitors as shown in Figure 28 and Figure 29. The 0.01  $\mu$ F and 0.1  $\mu$ F capacitors should be leadless SMT ceramic capacitors and should be no more than 3 mm from the supply pins. The SMT capacitors should be connected directly to a ground plane. Thin traces or small vias will reduce the effectiveness of bypass capacitors. Also shown in both figures is a capacitor from the  $V_{CM}$  pin to ground. The  $V_{CM}$  pin is a high impedance input to a buffer which sets the output common mode voltage. Any noise on this input is transferred directly to the output. Output common mode noise will result in loss of dynamic range, degraded CMRR, degraded Balance and higher distortion. The  $V_{CM}$  pin should be bypassed even if the pin in not used. There is an internal resistive divider on chip to set the output common mode voltage to the mid point of the supply pins. The impedance looking into this pin is approximately 25 k $\Omega$ . If a different output common mode voltage is desired drive this pin with a clean, accurate voltage reference.



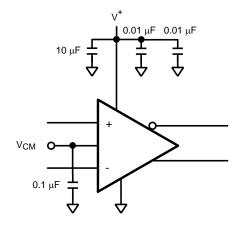


Figure 28. Split Supply Bypassing Capacitors

Figure 29. Single Supply Bypassing Capacitors



#### SINGLE ENDED INPUT TO DIFFERENTIAL OUTPUT

The LMH6551Q provides excellent performance as an active balun transformer. Figure 30 shows a typical application where an LMH6551Q is used to produce a differential signal from a single ended source.

In single ended input operation the output common mode voltage is set by the  $V_{CM}$  pin as in fully differential mode. Also, in this mode the common mode feedback circuit must recreate the signal that is not present on the unused differential input pin. Figure 25 is the measurement of the effectiveness of this process. The common mode feedback circuit is responsible for ensuring balanced output with a single ended input. Balance error is defined as the amount of input signal that couples into the output common mode. It is measured as a the undesired output common mode swing divided by the signal on the input. Balance error can be caused by either a channel to channel gain error, or phase error. Either condition will produce a common mode shift. Figure 25 measures the balance error with a single ended input as that is the most demanding mode of operation for the amplifier.

Supply and  $V_{CM}$  pin bypassing are also critical in this mode of operation. See the above section on FULLY DIFFERENTIAL OPERATION for bypassing recommendations and also see Figure 28 and Figure 29 for recommended supply bypassing configurations.

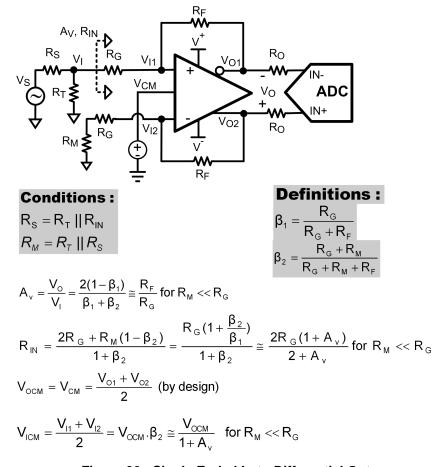


Figure 30. Single Ended In to Differential Out



#### SINGLE SUPPLY OPERATION

The input stage of the LMH6551Q has a built in offset of 0.7V towards the lower supply to accommodate single supply operation with single ended inputs. As shown in Figure 30, the input common mode voltage is less than the output common voltage. It is set by current flowing through the feedback network from the device output. The input common mode range of 0.4V to 3.2V places constraints on gain settings. Possible solutions to this limitation include AC coupling the input signal, using split power supplies and limiting stage gain. AC coupling with single supply is shown in Figure 31.

In Figure 30 closed loop gain =  $V_O$  /  $V_I \cong R_F$  /  $R_G$ , where  $V_I = V_S$  / 2, as long as  $R_M << R_G$ . Note that in single ended to differential operation  $V_I$  is measured single ended while  $V_O$  is measured differentially. This means that gain is really 1/2 or 6 dB less when measured on either of the output pins separately. Additionally, note that the input signal at  $R_T$  (labeled as  $V_I$ ) is 1/2 of  $V_S$  when  $R_T$  is chosen to match  $R_S$  to  $R_{IN}$ .

 $V_{ICM}$  = Input common mode voltage =  $(V_{11}+V_{12})/2$ .

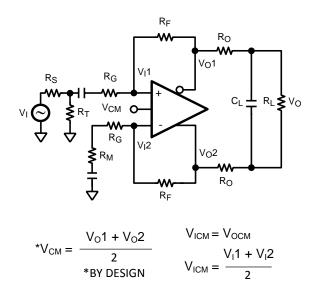


Figure 31. AC Coupled for Single Supply Operation

### **DRIVING ANALOG TO DIGITAL CONVERTERS**

Analog to digital converters (ADC) present challenging load conditions. They typically have high impedance inputs with large and often variable capacitive components. As well, there are usually current spikes associated with switched capacitor or sample and hold circuits. Figure 32 shows a typical circuit for driving an ADC. The two  $56\Omega$  resistors serve to isolate the capacitive loading of the ADC from the amplifier and ensure stability. In addition, the resistors form part of a low pass filter which helps to provide anti alias and noise reduction functions. The two 39 pF capacitors help to smooth the current spikes associated with the internal switching circuits of the ADC and also are a key component in the low pass filtering of the ADC input. In the circuit of Figure 32 the cutoff frequency of the filter is  $1/(2*\pi*56\Omega*(39 pF + 14pF)) = 53MHz$  (which is slightly less than the sampling frequency). Note that the ADC input capacitance must be factored into the frequency response of the input filter, and that being a differential input the effective input capacitance is double. Also as shown in Figure 32 the input capacitance to many ADCs is variable based on the clock cycle. See the data sheet for your particular ADC for details.

Product Folder Links: LMH6551Q



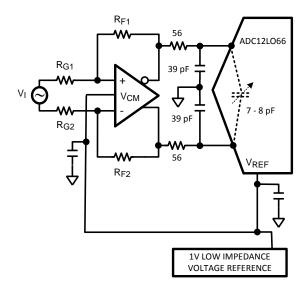


Figure 32. Driving an ADC

The amplifier and ADC should be located as closely together as possible. Both devices require that the filter components be in close proximity to them. The amplifier needs to have minimal parasitic loading on the output traces and the ADC is sensitive to high frequency noise that may couple in on its input lines. Some high performance ADCs have an input stage that has a bandwidth of several times its sample rate. The sampling process results in all input signals presented to the input stage mixing down into the Nyquist range (DC to Fs/2). See AN-236 (SNAA079) for more details on the subsampling process and the requirements this imposes on the filtering necessary in your system.

### **USING TRANSFORMERS**

Transformers are useful for impedance transformation as well as for single to differential, and differential to single ended conversion. A transformer can be used to step up the output voltage of the amplifier to drive very high impedance loads as shown in Figure 33. Figure 35 shows the opposite case where the output voltage is stepped down to drive a low impedance load.

Transformers have limitations that must be considered before choosing to use one. Compared to a differential amplifier, the most serious limitations of a transformer are the inability to pass DC and balance error (which causes distortion and gain errors). For most applications the LMH6551Q will have adequate output swing and drive current and a transformer will not be desirable. Transformers are used primarily to interface differential circuits to  $50\Omega$  single ended test equipment to simplify diagnostic testing.

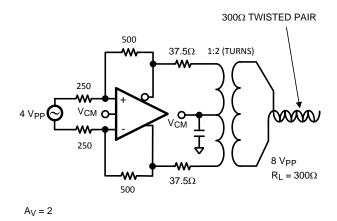


Figure 33. Transformer Out High Impedance Load



$$V_{L} = \frac{V_{IN} * A_{V} * N}{\left(\frac{2 R_{OUT} * N^{2}}{R_{L}} + 1\right)}$$

WHERE  $V_{IN} = DIFFERENTIAL INPUT VOLTAGE$ 

 $N = TRANSFORMER TURNS RATIO = \frac{SECONDARY}{PRIMARY}$ 

A<sub>V</sub> = CLOSED LOOP AMPLIFIER GAIN

 $R_{OUT} = SERIES OUTPUT MATCHING RESISTOR$ 

R<sub>L</sub> = LOAD RESISTOR

 $V_L = VOLTAGE ACROSS LOAD RESISTOR$ 

Figure 34. Calculating Transformer Circuit Net Gain

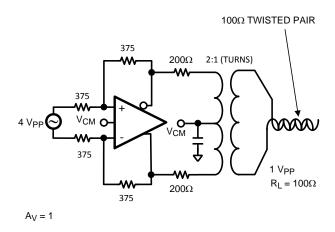
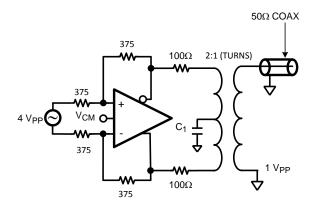


Figure 35. Transformer Out Low Impedance Load



 $\begin{aligned} & \text{GAIN} = 1 \\ & \text{C}_1 \text{ IS NOT REQUIRED IF V}_{\text{CM}} = & \text{GROUND} \end{aligned}$ 

Figure 36. Driving  $50\Omega$  Test Equipment

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#### **CAPACITIVE DRIVE**

As noted in DRIVING ANALOG TO DIGITAL CONVERTERS, capacitive loads should be isolated from the amplifier output with small valued resistors. This is particularly the case when the load has a resistive component that is  $500\Omega$  or higher. A typical ADC has capacitive components of around 10 pF and the resistive component could be  $1000\Omega$  or higher. If driving a transmission line, such as  $50\Omega$  coaxial or  $100\Omega$  twisted pair, using matching resistors will be sufficient to isolate any subsequent capacitance. For other applications see Figure 6 and Figure 7 in Typical Performance Characteristics.

#### POWER DISSIPATION

The LMH6551Q is optimized for maximum speed and performance in the small form factor of the standard VSSOP package, and is essentially a dual channel amplifier. To ensure maximum output drive and highest performance, thermal shutdown is not provided. Therefore, it is of utmost importance to make sure that the  $T_{\text{JMAX}}$  of 150°C is never exceeded due to the overall power dissipation.

Follow these steps to determine the Maximum power dissipation for the LMH6551Q:

1. Calculate the quiescent (no-load) power:

$$P_{AMP} = I_{CC}^* (V_S)$$

#### where

• 
$$V_S = V^+ - V^-$$
. (Be sure to include any current through the feedback network if  $V_{OCM}$  is not mid rail.) (1)

2. Calculate the RMS power dissipated in each of the output stages:

$$P_D$$
 (rms) = rms (( $V_S - V_{OUT}^+$ ) \*  $I_{OUT}^+$ ) + rms (( $V_S - V_{OUT}^-$ ) \*  $I_{OUT}^-$ )

#### where

V<sub>OUT</sub> and I<sub>OUT</sub> are the voltage and the current measured at the output pins of the differential amplifier as if they were single ended amplifiers and V<sub>S</sub> is the total supply voltage
 (2)

3. Calculate the total RMS power:

$$P_{T} = P_{AMP} + P_{D} \tag{3}$$

The maximum power that the LMH6551Q package can dissipate at a given temperature can be derived with the following equation:

$$P_{MAX} = (150^{\circ} - T_{AMB})/\theta_{JA}$$

### where

- T<sub>AMB</sub> = Ambient temperature (°C)
- $\theta_{JA}$  = Thermal resistance, from junction to ambient, for a given package (°C/W)
- θ<sub>JA</sub> is 159 °C/W for the VSSOP-8 package (4)

## **NOTE**

If  $V_{CM}$  is not 0V then there will be quiescent current flowing in the feedback network. This current should be included in the thermal calculations and added into the quiescent power dissipation of the amplifier.



Figure 37 shows the maximum power dissipation vs. ambient temperature for the VSSOP-8 package when mounted on a 4 layer JEDEC board.

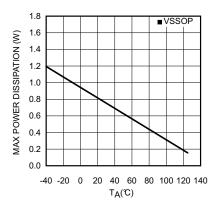


Figure 37. Maximum Power Dissipation vs. Ambient Temperature

At high ambient temperatures, the LMH6551Q's quiescent power dissipation approaches the maximum power shown in Figure 37, when operated close to the maximum operating supply voltage of 11V. This leaves little room for additional load power dissipation. In such applications, any of the following steps can be taken to alleviate any junction temperature concerns:

- Reduce the total supply voltage
- Reduce  $\theta_{JA}$  by increasing heatsinking possibly by either increasing the PC board area devoted to heatsinking or forced air cooling or both
- Reduce maximum ambient temperature

#### **ESD PROTECTION**

The LMH6551Q is protected against electrostatic discharge (ESD) on all pins. The LMH6551Q will survive 2000V Human Body model and 200V Machine model events. Under normal operation the ESD diodes have no effect on circuit performance. There are occasions, however, when the ESD diodes will be evident. If the LMH6551Q is driven by a large signal while the device is powered down the ESD diodes will conduct. The current that flows through the ESD diodes will either exit the chip through the supply pins or will flow through the device, hence it is possible to power up a chip with a large signal applied to the input pins.

### **BOARD LAYOUT**

The LMH6551Q is a very high performance amplifier. In order to get maximum benefit from the differential circuit architecture board layout and component selection is very critical. The circuit board should have low a inductance ground plane and well bypassed broad supply lines. External components should be leadless surface mount types. The feedback network and output matching resistors should be composed of short traces and precision resistors (0.1%). The output matching resistors should be placed within 3-4 mm of the amplifier as should the supply bypass capacitors.

The LMH6551Q is sensitive to parasitic capacitances on the amplifier inputs and to a lesser extent on the outputs as well. Ground and power plane metal should be removed from beneath the amplifier and from beneath  $R_{\rm F}$  and  $R_{\rm G}$ .

With any differential signal path symmetry is very important. Even small amounts of asymmetry will contribute to distortion and balance errors.

#### **EVALUATION BOARD**

Texas Instruments offers evaluation board(s) to aid in device testing and characterization and as a guide for proper layout. Generally, a good high frequency layout will keep power supply and ground traces away from the inverting input and output pins. Parasitic capacitances on these nodes to ground will cause frequency response peaking and possible circuit oscillations (see Application Note OA-15 for more information).

Product Folder Links: *LMH6551Q* 

## SNOSB95E -NOVEMBER 2011-REVISED MARCH 2013



# **REVISION HISTORY**

Cł	hanges from Revision D (March 2013) to Revision E	Pa	ıge
•	Changed layout of National Data Sheet to TI format		19

www.ti.com 23-May-2025

#### PACKAGING INFORMATION

Orderable part number	Status	Material type	Package   Pins	Package qty   Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow		(6)
						(4)	(5)		
LMH6551QMM/NOPB	Active	Production	VSSOP (DGK)   8	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q
LMH6551QMM/NOPB.A	Active	Production	VSSOP (DGK)   8	1000   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q
LMH6551QMME/NOPB	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q
LMH6551QMME/NOPB.A	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q
LMH6551QMMX/NOPB	Active	Production	VSSOP (DGK)   8	3500   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q
LMH6551QMMX/NOPB.A	Active	Production	VSSOP (DGK)   8	3500   LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-40 to 125	AU1Q

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

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# PACKAGE MATERIALS INFORMATION

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# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

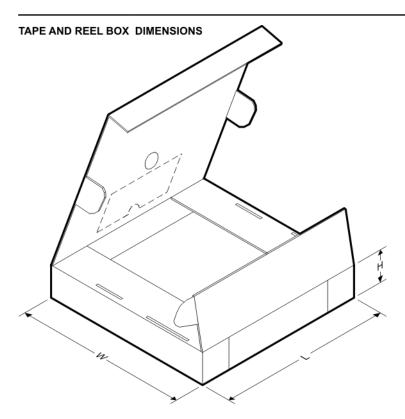
## QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMH6551QMM/NOPB	VSSOP	DGK	8	1000	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMH6551QMME/NOPB	VSSOP	DGK	8	250	178.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
LMH6551QMMX/NOPB	VSSOP	DGK	8	3500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1

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#### \*All dimensions are nominal

1	7 III dilitorio di Citto I i citti di							
	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
	LMH6551QMM/NOPB	VSSOP	DGK	8	1000	208.0	191.0	35.0
	LMH6551QMME/NOPB	VSSOP	DGK	8	250	208.0	191.0	35.0
	LMH6551QMMX/NOPB	VSSOP	DGK	8	3500	367.0	367.0	35.0



SMALL OUTLINE PACKAGE



### NOTES:

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- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-187.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
- 8. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.
- 9. Size of metal pad may vary due to creepage requirement.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 11. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 12. Board assembly site may have different recommendations for stencil design.



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